

# NCE N-Channel Enhancement Mode Power MOSFET

# Description

The NCE0224K uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

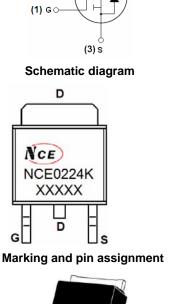
#### **General Features**

- $V_{DS} = 200V, I_D = 24A$  $R_{DS(ON)} < 80m\Omega @ V_{GS} = 10V$  (Typ:64m $\Omega$ )
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

#### Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

# 100% UIS TESTED!



(2) D

#### TO-252 top view

# 100% ΔVds TESTED! Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0224K	NCE0224K	TO-252	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25℃ unless otherwise noted)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		Vds	V <sub>DS</sub> 200		
Gate-Source Voltage		V <sub>GS</sub>	±20	V	
Drain Current-Continuous		Ι <sub>D</sub>	24	А	
Drain Current-Continuous	s(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃) 17			
Pulsed Drain Current (Note 1)		I <sub>DM</sub>	96	А	
Maximum Power Dissipat	tion	PD	150		
Single pulse avalanche e	nergy (Note 5)	E <sub>AS</sub>	250 r		
V <sub>DS</sub> Spike (Note 6)	10µs	24	240		
Operating Junction and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55 To 175	°C	
Thermal Charact	eristic	·	·	-	
Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>		R <sub>θJC</sub>	1	°C <b>/W</b>	



# Electrical Characteristics (T<sub>c</sub>=25<sup>°</sup>C unless otherwise noted)

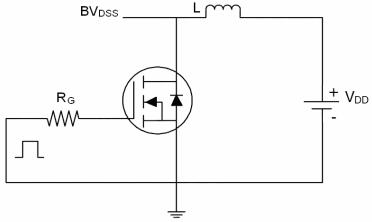
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	200	220	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =200V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	2.5	3.2	4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	64	80	mΩ
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =20A	30	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>			4565.8		PF
Output Capacitance	Coss	$V_{DS}$ =100V, $V_{GS}$ =0V,		87.2		PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz		70		PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	15	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =100V,I <sub>D</sub> =20A	-	20	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =2.5 $\Omega$	-	30	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	9	-	nS
Total Gate Charge	Qg	N/ 400X/1 00A		91.9		nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =100V,I <sub>D</sub> =20A,		21.8		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V		29.9		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-	-	1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	24	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = 20A	-	51	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	75	-	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

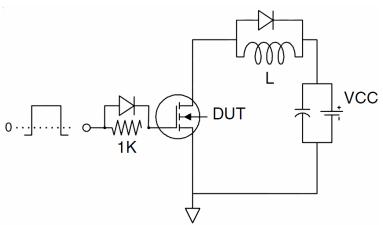
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, t  $\leq$  10 sec.
- **3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25  $^\circ \! \mathbb{C}$  ,V\_DD=50V,V\_G=10V,L=0.5mH,Rg=25 $\Omega$
- 6. The spike duty cycle 5% max, limited by junction temperature  $T_{\rm J}(MAX)\text{=}125^\circ~C$



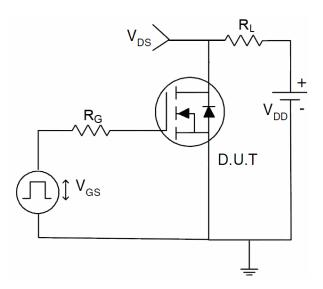
# Test Circuit 1) E<sub>AS</sub> test Circuits



# 2) Gate charge test Circuit

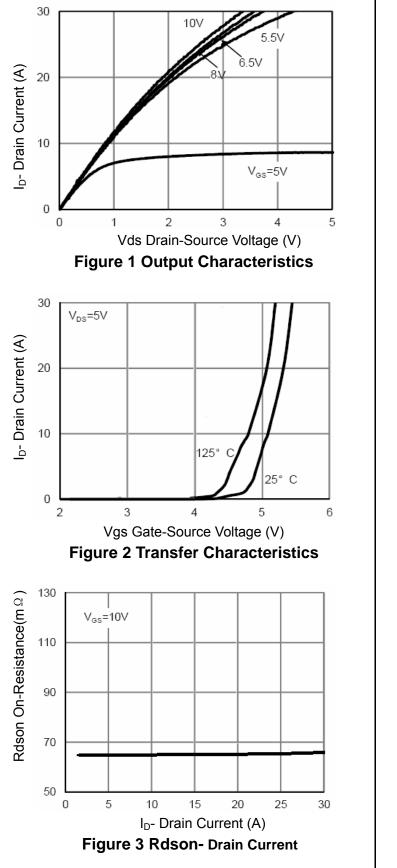


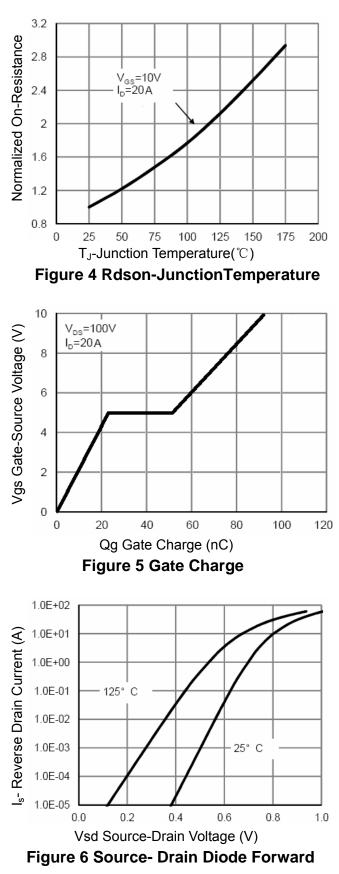
3) Switch Time Test Circuit





# **Typical Electrical and Thermal Characteristics (Curves)**

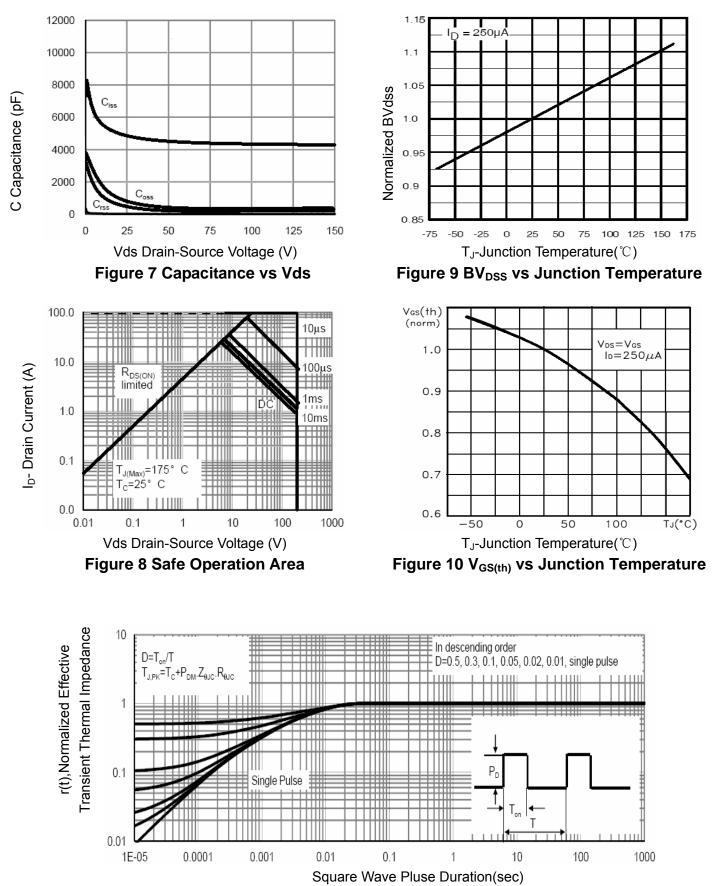






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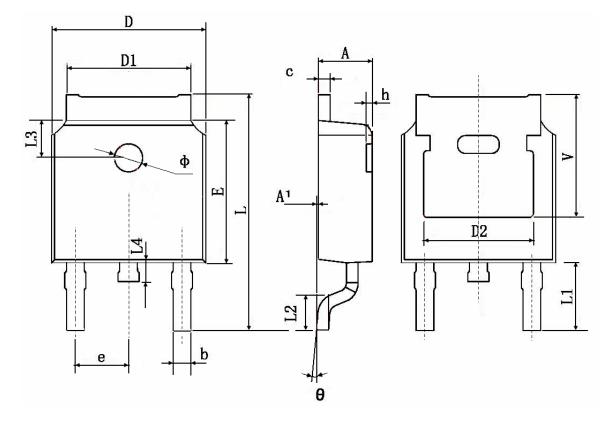
# NCE0224K







# **TO-252 Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.8	330 TYP.	0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Φ	1.100	1.300	0.043	0.051	
θ	0 °	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.35	0 TYP.	0.211 TYP.		



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